

DATA SHEET

74LV14

Hex inverting Schmitt-trigger

Product specification

1997 Feb 03

IC24 Data Handbook

Hex inverting Schmitt-trigger

74LV14

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for Low Voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7\text{ V}$ and $V_{CC} = 3.6\text{ V}$
- Typical V_{OLP} (output ground bounce) $< 0.8\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^\circ\text{C}$.
- Typical V_{OHV} (output V_{OH} undershoot) $> 2\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^\circ\text{C}$.
- Output capability: standard
- I_{CC} category: SSI

APPLICATIONS

- Wave and pulse shapers for highly noisy environments

DESCRIPTION

The 74LV14 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT14.

The 74LV14 provides six inverting buffers with Schmitt-trigger action. It is capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

QUICK REFERENCE DATA

$GND = 0\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $t_r = t_f \leq 2.5\text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay nA to nY	$C_L = 15\text{ pF}$; $V_{CC} = 3.3\text{ V}$	13	ns
C_I	Input capacitance		3.5	pF
C_{PD}	Power dissipation capacitance per gate	See Notes 1 and 2	15	pF

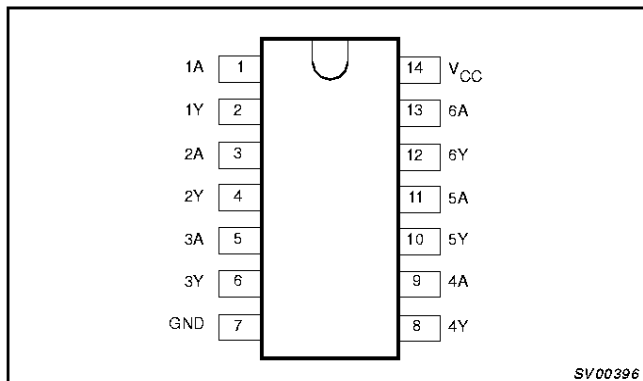
NOTES:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacity in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.
2. The condition is $V_I = GND$ to V_{CC} .

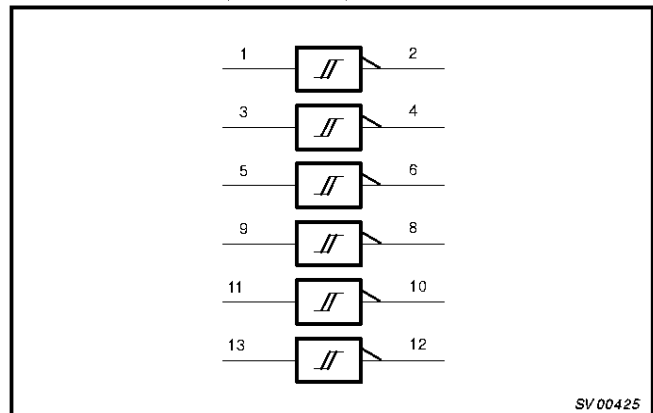
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	-40°C to $+125^\circ\text{C}$	74LV14 N	74LV14 N	SOT27-1
14-Pin Plastic SO	-40°C to $+125^\circ\text{C}$	74LV14 D	74LV14 D	SOT108-1
14-Pin Plastic SSOP Type II	-40°C to $+125^\circ\text{C}$	74LV14 DB	74LV14 DB	SOT337-1
14-Pin Plastic TSSOP Type I	-40°C to $+125^\circ\text{C}$	74LV14 PW	74LV14PW DH	SOT402-1

PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)



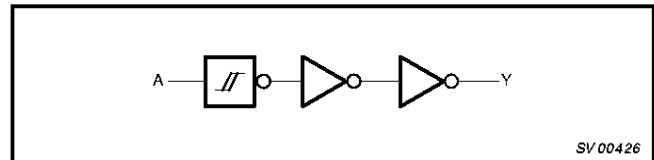
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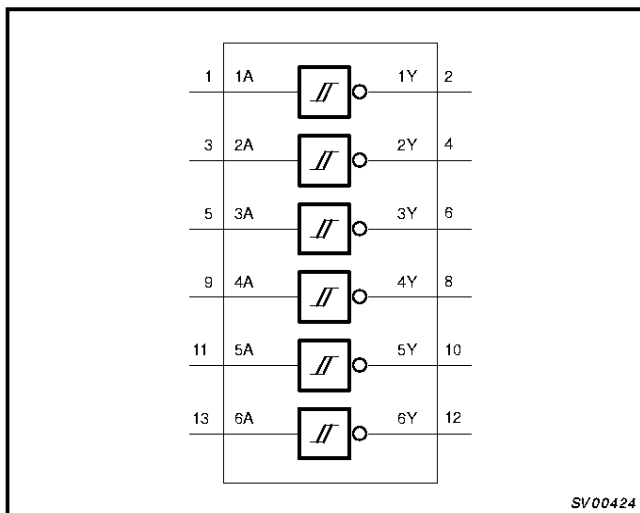
PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 5, 9, 11, 13	1A – 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y – 6Y	Data outputs
7	GND	Ground (0 V)
14	V _{CC}	Positive supply voltage

LOGIC DIAGRAM



LOGIC SYMBOL



FUNCTION TABLE

INPUT	OUTPUT
nA	nY
L	H
H	L

NOTES:

- H = HIGH voltage level
- L = LOW voltage level

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
±I _{IK}	DC input diode current	V _I < -0.5 or V _I > V _{CC} + 0.5V	20	mA
±I _{OK}	DC output diode current	V _O < -0.5 or V _O > V _{CC} + 0.5V	50	mA
±I _O	DC output source or sink current - standard outputs - bus driver outputs	-0.5V < V _O < V _{CC} + 0.5V	25 35	mA
±I _{GND} , ±I _{CC}	DC V _{CC} or GND current for types with - standard outputs - bus driver outputs		50 70	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package - plastic DIL - plastic mini-pack (SO) - plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	DC supply voltage	See Note ¹	1.0	3.3	5.5	V
V_I	Input voltage		0	–	V_{CC}	V
V_O	Output voltage		0	–	V_{CC}	V
T_{amb}	Operating ambient temperature range in free air	See DC and AC characteristics per device	–40 –40		+85 +125	°C
t_r, t_f	Input rise and fall times except for Schmitt-trigger inputs	$V_{CC} = 1.0V$ to $2.0V$ $V_{CC} = 2.0V$ to $2.7V$ $V_{CC} = 2.7V$ to $3.6V$ $V_{CC} = 3.6V$ to $5.5V$	– – – –	– – – –	500 200 100 50	ns/V

NOTE:

1. The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 5.5V$.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			–40°C to +85°C			–40°C to +125°C		
			MIN	TYP ¹	MAX	MIN	MAX	
V_{IH}	HIGH level Input voltage	$V_{CC} = 1.2V$	V_{CC}	0.6		V_{CC}		V
		$V_{CC} = 2.0V$	1.4		1.4			
		$V_{CC} = 2.7$ to $3.6V$	2.0		2.0			
		$V_{CC} = 4.5$ to $5.5V$	$0.7 \cdot V_{CC}$		$0.7 \cdot V_{CC}$			
V_{IL}	LOW level Input voltage	$V_{CC} = 1.2V$		0.4	GND		GND	V
		$V_{CC} = 2.0V$			0.6		0.6	
		$V_{CC} = 2.7$ to $3.6V$			0.8		0.8	
		$V_{CC} = 4.5$ to $5.5V$			$0.3 \cdot V_{CC}$		$0.3 \cdot V_{CC}$	
V_{OH}	HIGH level output voltage; all outputs	$V_{CC} = 1.2V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$		1.2				V
		$V_{CC} = 2.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$	1.8	2.0		1.8		
		$V_{CC} = 2.7V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$	2.5	2.7		2.5		
		$V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$	2.8	3.0		2.8		
		$V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; -I_O = 100\mu A$	4.3	4.5		4.3		
V_{OH}	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 6mA$	2.40	2.82		2.20		V
		$V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; -I_O = 12mA$	3.60	4.20		3.50		
V_{OH}	HIGH level output voltage; BUS driver outputs	$V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; -I_O = 8mA$	2.40	2.82		2.20		V
		$V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; -I_O = 16mA$	3.60	4.20		3.50		
V_{OL}	LOW level output voltage; all outputs	$V_{CC} = 1.2V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$		0				V
		$V_{CC} = 2.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 2.7V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; I_O = 100\mu A$		0	0.2		0.2	
V_{OL}	LOW level output voltage; STANDARD outputs	$V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 6mA$		0.25	0.40		0.50	V
		$V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; I_O = 12mA$		0.35	0.55		0.65	
V_{OL}	LOW level output voltage; BUS driver outputs	$V_{CC} = 3.0V; V_I = V_{IH}$ or $V_{IL}; I_O = 8mA$		0.20	0.40		0.50	V
		$V_{CC} = 4.5V; V_I = V_{IH}$ or $V_{IL}; I_O = 16mA$		0.35	0.55		0.65	
I_I	Input leakage current	$V_{CC} = 5.5V; V_I = V_{CC}$ or GND			1.0		1.0	μA
I_{OZ}	3-State output OFF-state current	$V_{CC} = 5.5V; V_I = V_{IH}$ or $V_{IL}; V_O = V_{CC}$ or GND			5		10	μA

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DC ELECTRICAL CHARACTERISTICS (Continued)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS				UNIT	
			-40°C to +85°C		-40°C to +125°C			
I _{CC}	Quiescent supply current; SSI	V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0			20.0		40	μA
	Quiescent supply current; flip-flops	V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0			20.0		80	
I _{CC}	Quiescent supply current; MSI	V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0			20.0		160	μA
	Quiescent supply current; LSI	V _{CC} = 5.5V; V _I = V _{CC} or GND; I _O = 0			500		1000	
ΔI _{CC}	Additional quiescent supply current	V _{CC} = 2.7V to 3.6V; V _I = V _{CC} - 0.6V			500		850	μA

NOTE:

1. All typical values are measured at T_{amb} = 25°C.

TRANSFER CHARACTERISTICS

Voltages are referenced to GND (ground = 0 V)

SYMBOL	PARAMETER	T _{amb} (°C)					UNIT	TEST CONDITIONS	
		-40 TO +85			-40 TO +125			V _{CC} (V)	WAVEFORMS
		MIN.	TYP.	MAX.	MIN.	MIN.			
V _{T+}	Positive-going threshold	–	0.70	–	–	–	V	1.2	Figure 1 and 2
		0.8	1.10	1.4	0.8	1.4			
		1.0	1.45	2.0	1.0	2.0			
		1.2	1.60	2.2	1.2	2.2			
		1.5	1.95	2.4	1.5	2.4			
		1.7	2.50	3.15	1.7	3.15			
		2.1	3.00	3.85	2.1	3.85			
V _{T-}	Negative-going threshold	–	0.34	–	–	–	V	1.2	Figure 1 and 2
		0.3	0.65	0.9	0.3	0.9			
		0.4	0.90	1.4	0.4	1.4			
		0.6	1.05	1.5	0.6	1.5			
		0.8	1.30	1.8	0.8	1.8			
		0.9	1.60	2.0	0.9	2.0			
		1.1	2.00	2.6	1.1	2.6			
V _H	Hysteresis (V _{T+} - V _{T-})	–	0.30	–	–	–	V	1.2	Figure 1 and 2
		0.2	0.55	0.8	0.2	0.8			
		0.3	0.60	1.1	0.3	1.1			
		0.4	0.65	1.2	0.4	1.2			
		0.4	0.70	1.2	0.4	1.2			
		0.4	0.80	1.4	0.4	1.4			
		0.6	1.00	1.5	0.6	1.5			

NOTES:

- All typical values are measured at T_{amb} = 25°C
- The V_{IH} and V_{IL} from the DC family characteristics are superseded by the V_{T+} and V_{T-}.

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AC CHARACTERISTICS

GND = 0V; $t_r = t_f = 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 500\Omega$

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				-40 to +85 °C			-40 to +125 °C		
				MIN	TYP ¹	MAX	MIN	MAX	
$t_{PHL/PLH}$	Propagation delay nA to nY	Figures 6, 7	$V_{CC}(\text{V})$						ns
			1.2		80				
			2.0		27	37		48	
			2.7		20	28		35	
			3.0 to 3.6		15 ²	22		28	
4.5 to 5.5			18		23				

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^\circ\text{C}$
2. Typical values are measured at $V_{CC} = 3.3\text{V}$.

TRANSFER CHARACTERISTIC WAVEFORMS

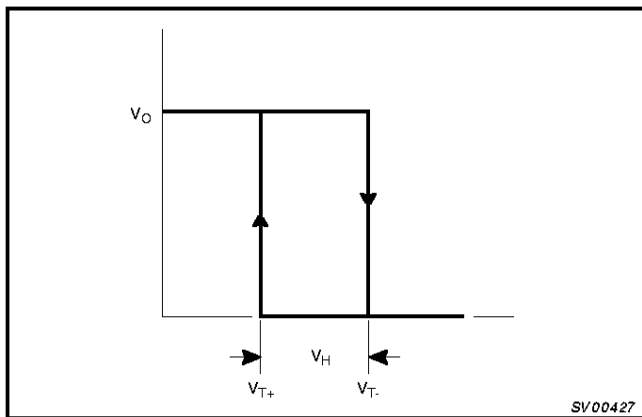


Figure 1. Transfer characteristic.

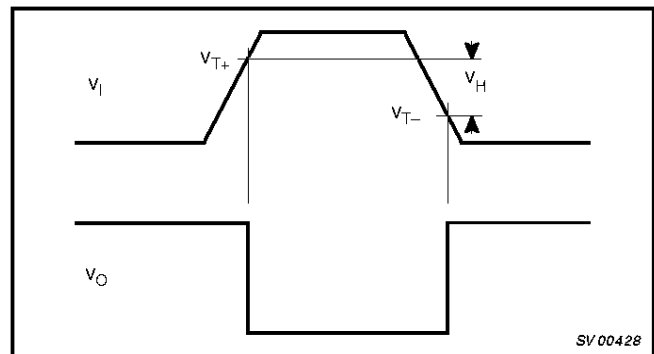


Figure 2. Definition of V_{T+} , V_{T-} and V_H ; where V_{T+} and V_{T-} are between limits of 20% and 70%

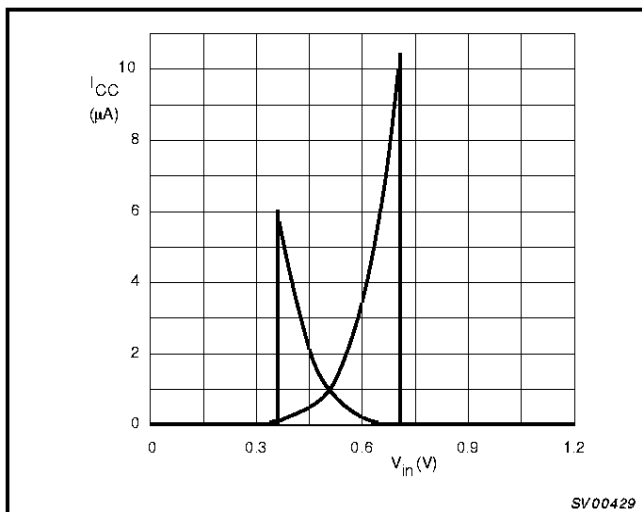


Figure 3. Typical 74LV14 transfer characteristics; $V_{CC} = 1.2\text{V}$.

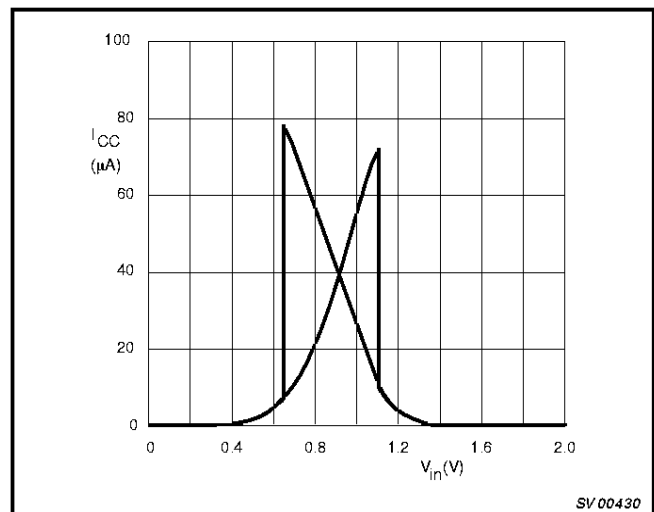


Figure 4. Typical 74LV14 transfer characteristics; $V_{CC} = 2.0\text{V}$.

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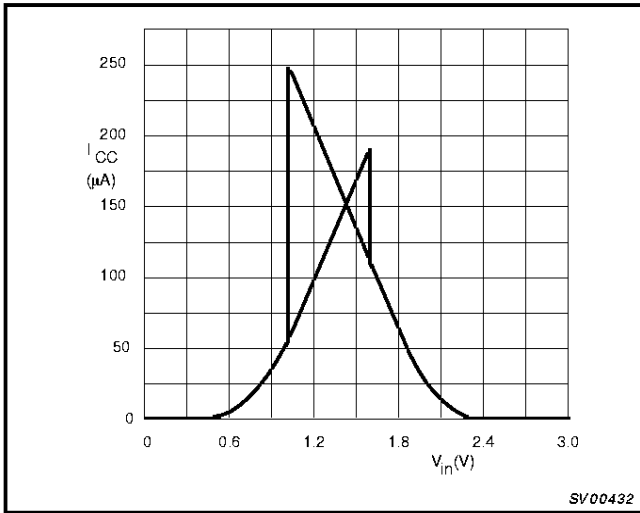


Figure 5. Typical 74LV14 transfer characteristics; $V_{CC} = 3.0V$.

AC WAVEFORMS

$V_M = 1.5 V$ at $V_{CC} \geq 2.7 V$;

$V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7 V$

V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

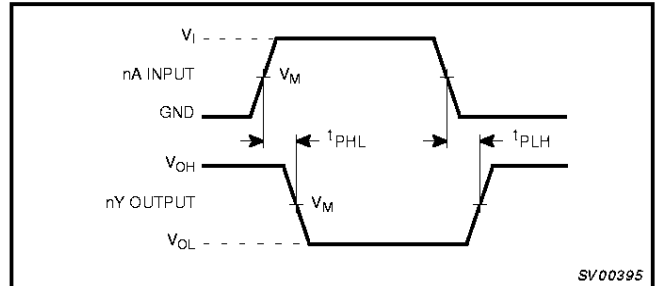


Figure 6. Input (nA) to output (nY) propagation delays.

TEST CIRCUIT

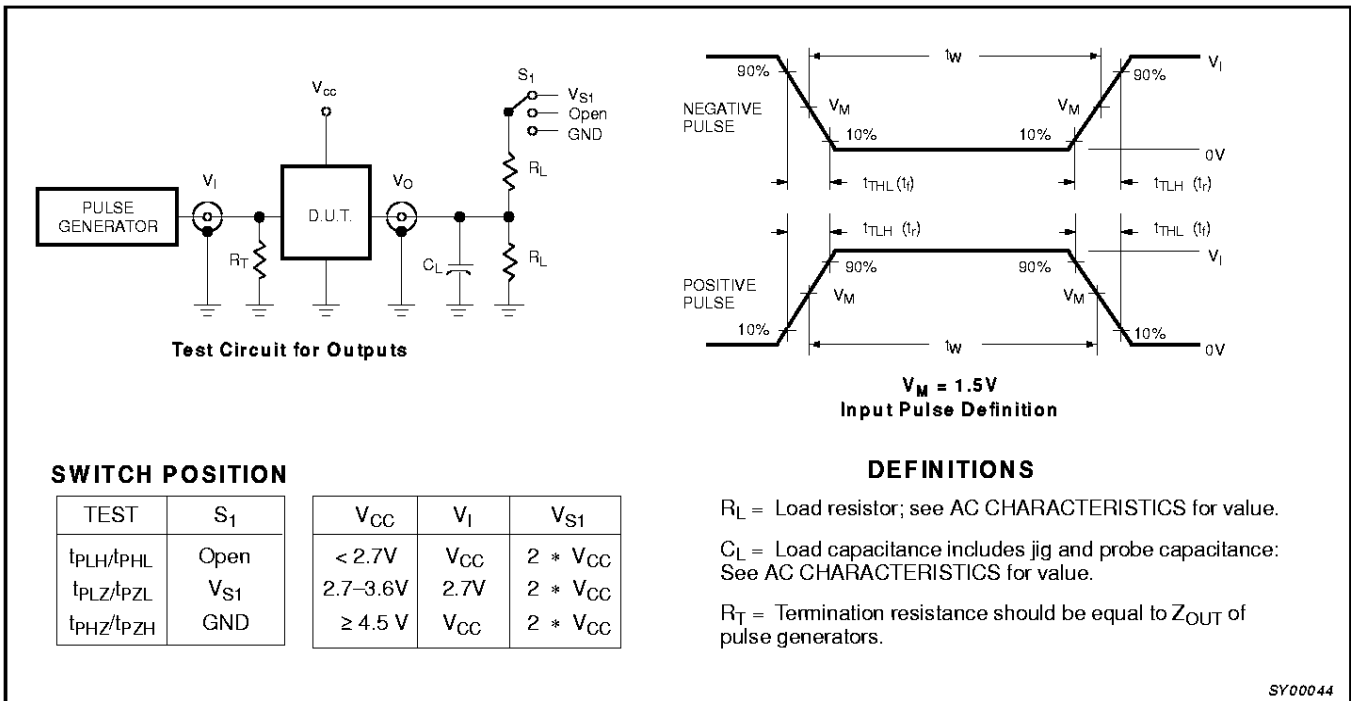


Figure 7. Load circuitry for switching times

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APPLICATION INFORMATION

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

$$P_{ad} = f_i \times (t_r \times I_{CCa} + t_f \times I_{CCa}) \times V_{CC}$$

Where:

P_{ad} = additional power dissipation (μW)

f_i = input frequency (MHz)

t_r = input rise time (ns); 10% – 90%

t_f = input fall time (ns); 10% – 90%

I_{CCa} = average additional supply current (μA)

Average I_{CCa} differs with positive or negative input transitions, as shown in Figure 8.

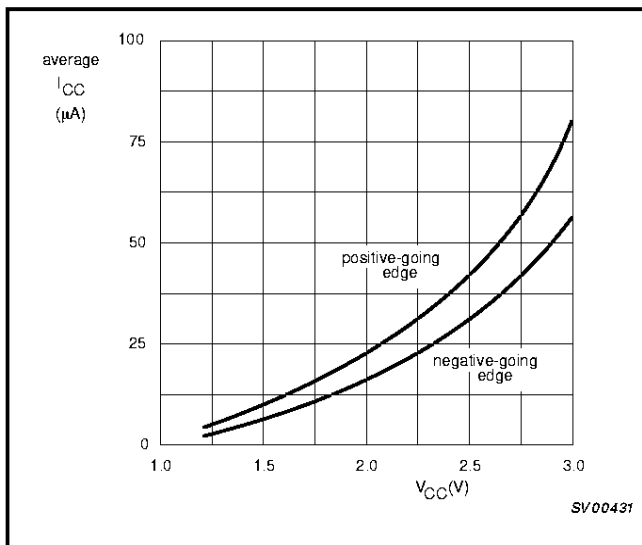


Figure 8. Average I_{CC} for LV Schmitt-trigger devices; linear change of V_I between $0.1 V_{CC}$ to $0.9 V_{CC}$.

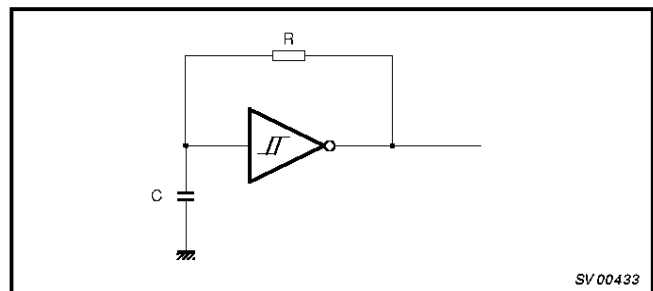


Figure 9. Relaxation oscillator using the LV14.

Note to application information:

All values given are typical unless otherwise specified.

Note to Figure 9

$$f = \frac{1}{T} \approx \frac{1}{0.8 \times RC}$$

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DIP14: plastic dual in-line package; 14 leads (300 mil)

SOT27-1

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

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TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

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NOTES

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DEFINITIONS

Data Sheet Identification	Product Status	Definition
<i>Objective Specification</i>	Formative or In Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
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